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Panasonic

Transistors with Built-in Resistor DRA3143E0L

DRA3143E0L Silicon PNP epitaxial planar type

For digital circuits Complementary to DRC3143E

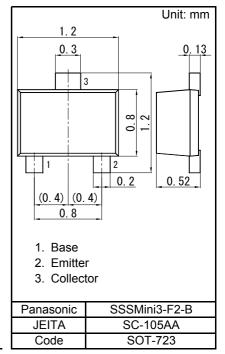
DRA9143E in SSSMini3 type package

Features

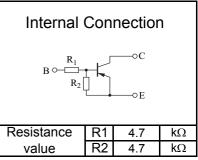
- Low collector-emitter saturation voltage Vce(sat) ٠
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: L5

Packaging

Embossed type (Thermo-compression sealing) : 10 000 pcs / reel (standard)



| Parameter | Symbol | Rating | Unit | - |
|---------------------------------------|--------|-------------|------|-------|
| Collector-base voltage (Emitter open) | VCBO | -50 | V | |
| Collector-emitter voltage (Base open) | VCEO | -50 | V | Inter |
| Collector current | IC | -100 | mA | |
| Total power dissipation | PT | 100 | mW | |
| Junction temperature | Tj | 150 | °C | ВО |
| Operating ambient temperature | Topr | -40 to +85 | °C | |
| Storage temperature | Tstg | -55 to +150 | °C | |
| | | | | |



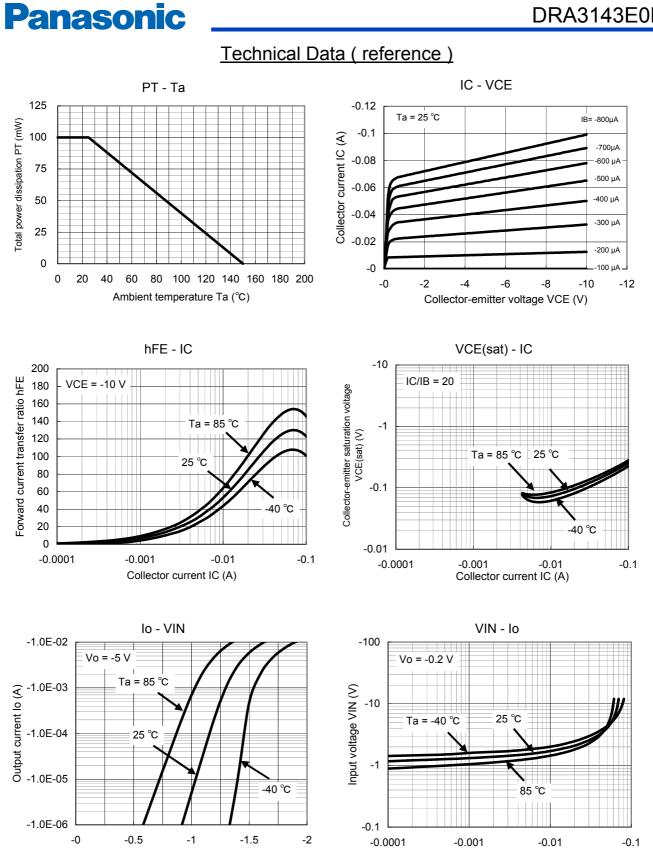
■ Electrical Characteristics Ta = 25 °C ± 3 °C

Absolute Maximum Ratings Ta = 25 °C

| Symbol | Conditions | Min | Тур | Max | Unit | | | | |
|----------|--|--|--|--|--|--|--|--|--|
| VCBO | IC = -10 μA, IE = 0 | -50 | | | V | | | | |
| VCEO | IC = -2 mA, IB = 0 | -50 | | | V | | | | |
| ICBO | VCB = -50 V, IE = 0 | | | -0.1 | μA | | | | |
| ICEO | VCE = -50 V, IB = 0 | | | -0.5 | μA | | | | |
| IEBO | VEB = -6 V, IC = 0 | | | -2.0 | mA | | | | |
| hFE | VCE = -10 V, IC = -5 mA | 20 | | | - | | | | |
| VCE(sat) | IC = -10 mA, IB = -0.5 mA | | | -0.25 | V | | | | |
| Vi(on) | VCE = -0.2 V, IC = -5 mA | -1.9 | | | V | | | | |
| Vi(off) | VCE = -5 V, IC = -100 μA | | | -0.8 | V | | | | |
| R1 | | -30% | 4.7 | +30% | kΩ | | | | |
| R1/R2 | | 0.8 | 1.0 | 1.2 | - | | | | |
| | Symbol VCBO ICBO ICEO IEBO hFE VCE(sat) Vi(on) Vi(off) R1 | Symbol Conditions VCBO IC = -10 μ A, IE = 0 VCEO IC = -2 mA, IB = 0 ICBO VCB = -50 V, IE = 0 ICEO VCE = -50 V, IB = 0 IEBO VEB = -6 V, IC = 0 hFE VCE = -10 V, IC = -5 mA VCE(sat) IC = -10 mA, IB = -0.5 mA Vi(on) VCE = -5 V, IC = -100 μ A R1 | $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | | | | |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

Transistors with Built-in Resistor **DRA3143E0L**



Page 2 of 3

Output current Io (A)

Established : 2009-10-23 Revised : 2014-02-12

Input voltage VIN (V)



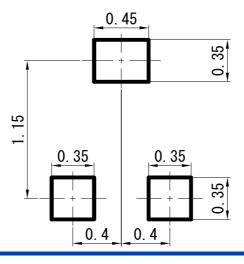
SSSMini3-F2-B

Transistors with Built-in Resistor DRA3143E0L

Unit: mm

1.20 ± 0.05 0.13-0.02 **0. 30**^{+0. 05} 0. 02 3 0.80±0.05 1.20 ± 0.05 20 2 1 **0. 20**+0. 05 -0. 02 0.20 ± 0.05 (0.4) (0.4) 0.80 ± 0.05 (5°) 27) 52 ± 0.03 ġ o' 0 to 0.05

Land Pattern (Reference) (Unit: mm)



Page 3 of 3

Established : 2009-10-23 Revised : 2014-02-12

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